

NFC Forum Chairs
as of April 2021

Group	Chair	Co-Chair or Vice-Chair	Secretary
Board of Directors	Koichi Tagawa, Dai Nippon Printing	Preeti Ohri Khemani, Infineon Technologies (Vice Chair) Fabrice Punch, NXP Semiconductors (Vice Chair)	Frank Dawidowsky, Sony
Group	Chair	Co-Chair or Vice-Chair	Secretary
Technical Committee	Jürgen Böhler, STMicroelectronics	Michael Stark, NXP Semiconductors (Vice-Chair)	
Analog Working Group	Mohammed Ratni, Sony	Andreas Wörle, Infineon Technologies	
Wireless Charging Task Force	Hannes Mock, CISC Semiconductor	Jean-Rémi Ruiz, STMicroelectronics (Vice-Chair)	
NFC Devices Working Group	Klaus Roehrle, Sony	John Hillan, Qualcomm (Vice-Chair)	
Unidirectional Tag Task Force	Cosmin Pascu, PragmatIC	Brian Cobb, PragmatIC (Vice-Chair)	
Digital Working Group	Michael Stark, NXP Semiconductors	Brian Cobb, PragmatIC (Vice-Chair)	
Reference Applications Framework Working Group	Daniel Orsatti, STMicroelectronics		
Security Working Group			

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Compliance Committee	Henk Dannenberg, NXP Semiconductors	Cosmin Pascu, PragmatIC (Vice-Chair)	
Requirements and Policy Working Group	Michael Stark, NXP Semiconductors	Jose Mangione, STMicroelectronics (Vice-Chair)	
Testing Working Group	Erwan Le Fer, National Instruments, formerly Micropross		
RF Testing Task Force	Jean-Rémi Ruiz, STMicroelectronics	Arnaud Schreiner, NXP Semiconductors	
Wireless Charging Testing Task Force	Arnaud Schreiner, NXP Semiconductors	Erwan Lefer, Micropross (Vice-Chair)	
Group	Chair	Co-Chair or Vice-Chair	Secretary
Special Interest Group (SIG) Committee	Koichi Tagawa, Dai Nippon Printing		
Japan Task Force	Masao Yamada, Dai Nippon Printing		
Automotive SIG	Rainer Lutz, NXP Semiconductors	Cristian Saracin, Continental Automotive GmbH	
Internet of Things SIG	Zanghee Cho, NXP Semiconductor	Preeti Ohri Khemani, Infineon Technologies (Vice Chair)	
Healthcare Task Force	Amir Khoshniyati, Avery Dennison		
Retail & Payment SIG	Bruno Carpreau, Mastercard	Ursula Schilling, Infineon Technologies	
Mobility, Identity, and Transport SIG	Preeti Ohri Khemani, Infineon Technologies	Hisayoshi Endo, Dai Nippon Printing Co., Ltd.	